

# 54F/74F821 10-Bit D-Type Flip-Flop

## **General Description**

The 'F821 is a 10-bit D-type flip-flop with TRI-STATE® true outputs arranged in a broadside pinout. The 'F821 is functionally and pin compatible with the AMD's Am29821.

### **Features**

- TRI-STATE Outputs
- Direct replacement for AMD's Am29821

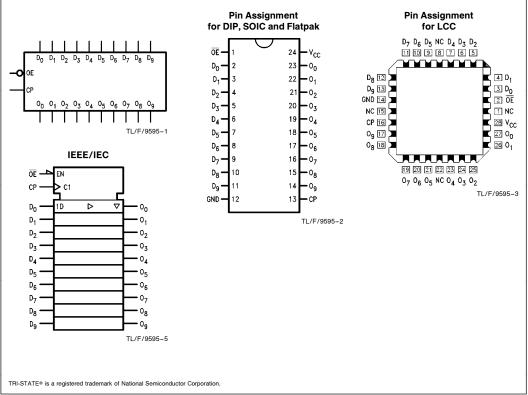
Commercial	Military	Package Number	Package Description		
74F821SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line		
	54F821SDM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line		
74F821SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC		
	54F821FM (Note 2)	W24C	24-Lead Cerpack		
	54F821LM (Note 2)	E28A	24-Lead Ceramic Leadless Chip Carrier, Type C		

Note 1: Devices also available in 13" reel. Use suffix = SCX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = SDMQB, FMQB and LMQB.

#### **Logic Symbols**

## **Connection Diagrams**



# **Unit Loading/Fan Out**

		54F/74F					
Pin Names Description		U.L. HIGH/LOW	Input I <sub>IH</sub> /I <sub>IL</sub> Output I <sub>OH</sub> /I <sub>OL</sub>				
D <sub>0</sub> -D <sub>9</sub>	Data Inputs	1.0/1.0	20 μA/-0.6 mA				
ŌĒ	Output Enable TRI-STATE Input	1.0/1.0	20 μA/ - 0.6 mA				
CP	Clock Input	1.0/1.0	20 μA/ – 0.6 mA				
O <sub>0</sub> -O <sub>9</sub>	TRI-STATE Outputs	150/40 (33.3)	-3.0 mA/24 mA (20 mA)				

## **Functional Description**

The 'F821 consists of ten D-type edge-triggered flip-flops. This device has TRI-STATE true outputs for bus systems organized in a broadside pinning. The buffered Clock (CP) and buffered Output Enable  $(\overline{OE})$  are common to all flipflops. The flip-flops will store the state of their individual D inputs that meet the setup and hold times requirements on the LOW-to-HIGH CP transition. With the  $\overline{\text{OE}}$  LOW the content of the flip-flops are available at the outputs. When the  $\overline{\text{OE}}$  is HIGH, the outputs go to the high impedance state. Operation of the  $\overline{\text{OE}}$  input does not affect the state of the flip-flops.

#### **Function Table**

I	Inputs		Internal	Output	Function
ŌĒ	СР	D	Q	0	Tunotion
H H	H L	X X	NC NC	Z Z	Hold Hold
Н	$\mathcal{L}$	L	Н	Z	Load
Н	$\mathcal{L}$	Н	L	Z	Load
L		L	Н	L	Data Available
L	$\mathcal{L}$	Н	L	Н	Data Available
L	Н	Х	NC	NC	No Change in Data
L	L	Х	NC	NC	No Change in Data

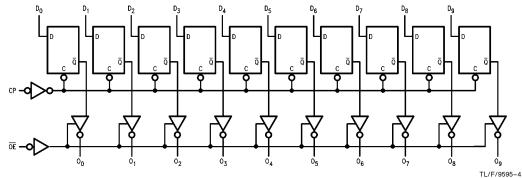
L = LOW Voltage Level

H = HIGH Voltage Level X = Immaterial

Z = High Impedance

✓ = LOW-to-HIGH Transition NC = No Change

# **Logic Diagram**



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

#### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to} + 125^{\circ}\mbox{C} \\ \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to} + 175^{\circ}\mbox{C} \\ \mbox{Plastic} & -55^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \end{array}$ 

V<sub>CC</sub> Pin Potential to

Ground Pin -0.5V to +7.0V Input Voltage (Note 2) -0.5V to +7.0V Input Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Output in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{ll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{TRI-STATE Output} & -0.5 \text{V to } +5.5 \text{V} \end{array}$ 

Current Applied to Output

in LOW State (Max) twice the rated I<sub>OL</sub> (mA)

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# Recommended Operating Conditions

Free Air Ambient Temperature

Military  $-55^{\circ}\text{C to} + 125^{\circ}\text{C}$ Commercial  $0^{\circ}\text{C to} + 70^{\circ}\text{C}$ 

Supply Voltage

Military + 4.5V to + 5.5V Commercial + 4.5V to + 5.5V

## **DC Electrical Characteristics**

Symbol	Parameter .		54F/74F			Units	Vcc	Conditions	
Syllibol			Min	Тур	Max	Units	VCC	Conditions	
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signa	
V <sub>IL</sub>	Input LOW Voltage				0.8	V		Recognized as a LOW Signa	
V <sub>CD</sub>	Input Clamp Diode Voltage				-1.2	V	Min	$I_{\text{IN}} = -18  \text{mA}$	
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub> 54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 5% V <sub>CC</sub> 74F 5% V <sub>CC</sub>	2.5 2.4 2.5 2.4 2.7 2.7			V	Min	$I_{OH} = -1 \text{ mA}$ $I_{OH} = -3 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -3 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -3 \text{ mA}$	
V <sub>OL</sub>	Output LOW Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub>			0.5 0.5	٧	Min	I <sub>OL</sub> = 20 mA I <sub>OL</sub> = 24 mA	
I <sub>IH</sub>	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	$V_{IN} = 2.7V$	
I <sub>BVI</sub>	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	V <sub>IN</sub> = 7.0V	
I <sub>CEX</sub>	Output HIGH Leakage Current	54F 74F			250 50	μΑ	Max	$V_{OUT} = V_{CC}$	
V <sub>ID</sub>	Input Leakage Test	74F	4.75			٧	0.0	$I_{\text{ID}} = 1.9  \mu\text{A},$ All Other Pins Grounded	
I <sub>OD</sub>	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded	
I <sub>IL</sub>	Input LOW Current				-0.6	mA	Max	V <sub>IN</sub> = 0.5V	
lozh	Output Leakage Current				50	μΑ	Max	V <sub>OUT</sub> = 2.7V	
l <sub>OZL</sub>	Output Leakage Current				-50	μΑ	Max	V <sub>OUT</sub> = 0.5V	
los	Output Short-Circuit Current		-60		<b>-150</b>	mA	Max	$V_{OUT} = 0V$	
Iccz	Power Supply Curren	t		78	100	mA	Max	V <sub>O</sub> = HIGH Z	

# **AC Electrical Characteristics**

Symbol	Parameter				T <sub>A</sub> , V <sub>C</sub>	4F C = Mil 50 pF	74F  T <sub>A</sub> , V <sub>CC</sub> = Com C <sub>L</sub> = 50 pF		Units
		Min	Тур	Max	Min	Max	Min	Max	
f <sub>max</sub>	Maximum Clock Frequency	100	150		60		70		MHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay CP to O <sub>n</sub>	2.0 2.0	6.4 6.2	9.5 9.5	2.0 2.0	10.5 10.5	2.0 2.0	10.5 10.5	ns
t <sub>PZH</sub>	Output Enable Time OE to On	2.0 2.0	5.8 6.3	10.5 10.5	2.0 2.0	13.0 13.0	2.0 2.0	11.5 11.5	ns
t <sub>PHZ</sub>	Output Disable Time  OE to On	1.5 1.5	3.4 3.5	7.0 7.0	1.0 1.0	7.5 7.5	1.5 1.5	7.5 7.5	115

# **AC Operating Requirements**

		$74F$ $T_A = +25^{\circ}C$ $V_{CC} = +5.0V$		54	F	74F		
Symbol	Parameter			${\sf T_A,V_{CC}}={\sf Mil}$		T <sub>A</sub> , V <sub>CC</sub> = Com		Units
		Min	Max	Min	Max	Min	Max	
t <sub>s</sub> (H) t <sub>s</sub> (L)	Setup Time, HIGH or LOW D <sub>n</sub> to CP	2.5 2.5		4.0 4.0		3.0 3.0		- ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold Time, HIGH or LOW D <sub>n</sub> to CP	2.5 2.5		2.5 2.5		2.5 2.5		
t <sub>w</sub> (H)	CP Pulse Width HIGH or LOW	5.0 5.0		6.0 6.0		6.0 6.0		ns

## **Ordering Information**

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

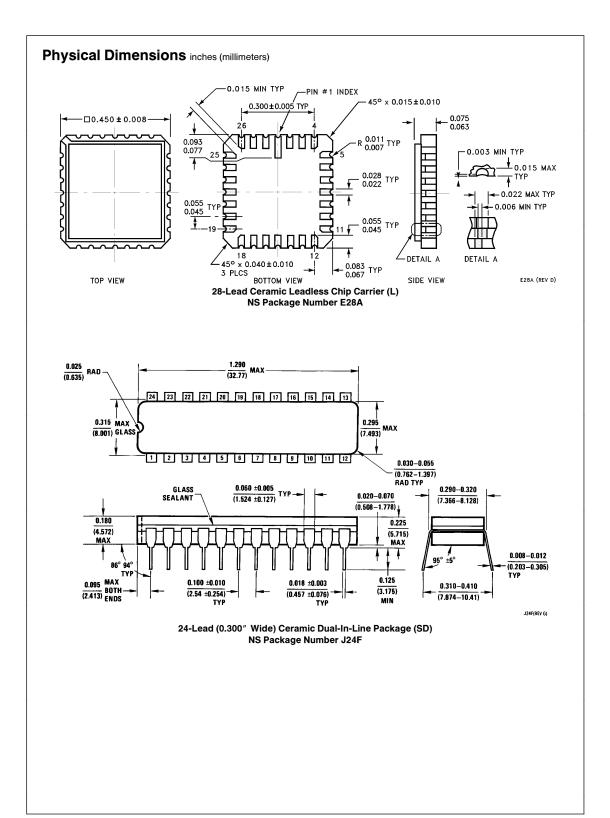
Temperature Range Family
74F = Commercial FAST
54F = Military FAST

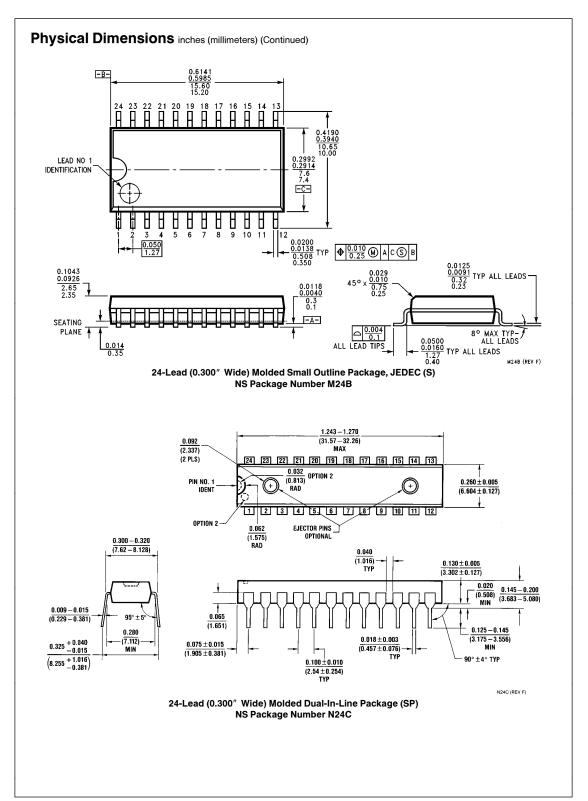
Device Type
Package Code
SP = Slim Plastic DIP
SD = Slim Ceramic DIP

Temperature Range
C = Commercial (0°C to +70°C)
M = Military grade device with environmental and burn-in processing
X = Devices ship in 13" reel

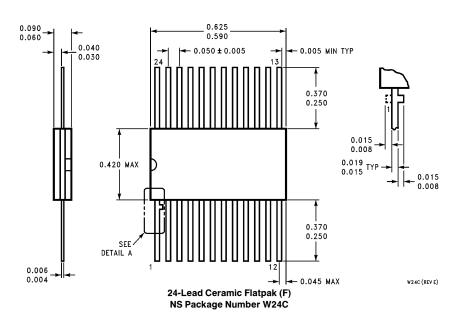
Temperature Range
C = Commercial (0°C to +70°C)
M = Military (-55°C to +125°C)

F = Flatpak
L = Leadless Chip Carrier (LCC)
S = Small Outline (SOIC)





# Physical Dimensions inches (millimeters) (Continued)



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